



D5V0M1U2S9

Product Summary

V _{BR min}	Ipp max	Cin typ
6.2V	9A	54pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as cellular phones, digital cameras, and MP3 players.

Applications

- Cellular Handsets
- Portable Electronics
- Computers and Peripheral

Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±30kV, Contact ±30kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)

SURFACE MOUNT UNIDIRECTIONAL TVS DIODE

Halogen and Antimony Free. "Green" Device (Note 3)

Mechanical Data

- Case: SOD923
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.001 grams (Approximate)



SOD923

Top View



Device Schematic

Ordering Information (Note 4)

Product	Compliance	Marking	Reel Size (inches)	Tape Width (mm)	Quantity per Reel
D5V0M1U2S9-7	Standard	TH	7	8	10,000/Tape & Reel

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at http"//www.diodes.com/products/packages.html.

Marking Information





TH = Product Type Marking Code Line Denotes Pin 1 or Cathode side

Maximum Ratings (@TA = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Conditions
Peak Pulse Power Dissipation	P _{PP}	108	W	8/20µs, per Figure 3
Peak Pulse Current	IPP	9.0	А	8/20µs, per Figure 3
ESD Protection – Contact Discharge	VESD_Contact	±30	kV	IEC 61000-4-2 Standard
ESD Protection – Air Discharge	V _{ESD_Air}	±30	kV	IEC 61000-4-2 Standard



Thermal Characteristics

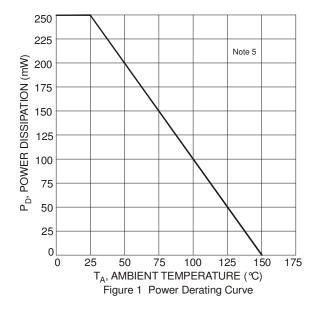
Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	$R_{ extsf{ heta}JA}$	500	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	C

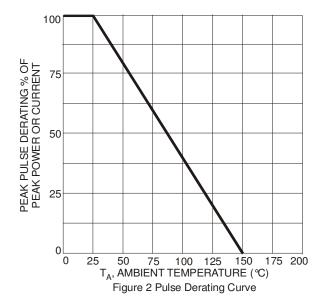
Electrical Characteristics (@T_A = +25 °C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Conditions
Reverse Standoff Voltage	V _{RWM}	_	_	5.5	V	—
Channel Leakage Current (Note 6)	I _{RM}	_	—	1.0	μA	V _{RWM} = 5V
Clamping Voltage, Positive Transients	V _{CL}	_	—	12	V	I _{PP} = 9A, t _p = 8/20µS
Breakdown Voltage	V _{BR}	6.2	—	—	V	I _R = 1mA
Channel Input Capacitance	CIN	_	54	64	pF	V _R = 0V, f = 1MHz

Notes: 5. Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes, Inc. suggested pad layout AP02001, which can be found on our website at http://www.diodes.com.

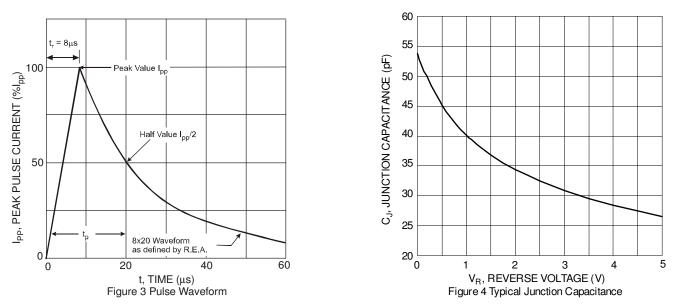
6. Short duration pulse test used to minimize self-heating effect.





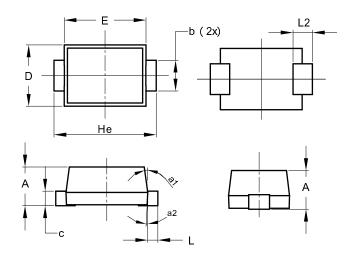


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Package Outline Dimensions

Please see AP02002 at http://www.diodes.com/datasheets/ap02002.pdf for the latest version.

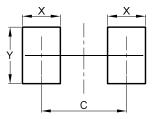


	SOD923					
(0.	(0.3mm Lead Width)					
Dim	Min	Max	Тур			
Α	0.34	0.40	0.37			
b	0.25	0.35	0.30			
С	0.05	0.15	0.10			
D	0.55	0.65	0.60			
Е	0.75	0.85	0.80			
He	0.95	1.05	1.00			
L	0.05	0.15	0.10			
L2	L2 0.190 REF					
a1	0°	8°	7°			
a2	2°	4°	3°			
All	All Dimensions in mm					



Suggested Pad Layout

Please see AP02001 at http://www.diodes.com/datasheets/ap02001.pdf for the latest version.



Dimensions	Value		
Dimensions	(in mm)		
С	0.900		
Х	0.400		
Y	0.600		

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